Radial, Molded, X7R Dielectric, 50 – 200 VDC (Commercial Grade)



Overview

KEMET's epoxy molded radial through-hole ceramic capacitors in X7R dielectric feature an 125°C maximum operating temperature and are considered "temperature stable." The Electronics Industries Alliance (EIA) characterizes X7R dielectric as a Class II material. Components of this classification are fixed, ceramic dielectric capacitors suited for bypass and decoupling applications or for frequency discriminating

circuits where Q and stability of capacitance characteristics are not critical. X7R exhibits a predictable change in capacitance with respect to time and voltage and boasts a minimal change in capacitance with reference to ambient temperature. Capacitance change is limited to ±15% from -55°C to +125°C. These devices meet the flame test requirements outlined in UL Standard 94 V-0.

Benefits

- · Radial through-hole form factor
- Molded case
- -55°C to +125°C operating temperature range
- RoHS Compliant
- · X7R temperature stable dielectric
- DC voltage ratings of 50 V, 100 V and 200 V
- Capacitance offerings ranging from 10 pF to 3.3 μF
- Available capacitance tolerances of ±10% and ±20%
- · Non-polar device, minimizing installation concerns
- SnPb-plated lead finish (60/40)

- 100% pure matte tin-plated lead finish option available upon request (RoHS)
- Encapsulation meets flammability standard UL 94 V-0



Ordering Information

C	062	C	105	K	1	R	5	Т	A	7301
Ceramic	Style /Size	Specification/ Series	Capacitance Code (pF)	Capacitance Tolerance ¹	Rated Voltage (VDC)	Dielectric	Design	Lead Finish ²	Failure Rate	Packaging/Grade (C-Spec) ³
	052 062 512 522	C = Standard	Two significant digits and number of zeros	K = ±10% M = ±20%	5 = 50 1 = 100 2 = 200	R = X7R	5 = Multilayer	T = 100% Matte Sn C = SnPb (60/40)	A = N/A	Blank = Bulk 7301 = 12" Reel 7303 = 12" Reel 7293 = Ammo Pack

¹ Additional capacitance tolerance offerings may be available. Contact KEMET for details.

Standard: 60% tin (Sn)/40% lead (Pb) finish with 100% copper core ("C" designation).

Optional (C052 & C062 only): 100% matte tin (Sn) with nickel (Ni) underplate and steel core ("T" designation).

Alternative lead materials and finishes may be available. Contact KEMET for details.

C-Spec 7301: Recommended for straight lead configuration part types.

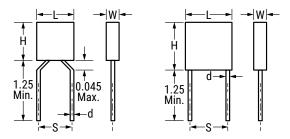
C-Spec 7301: Recommended for formed (bent) lead configuration part types.

² Lead materials and finishes:

³ Reeling options:



Dimensions - Inches (Millimeters)



Series	Style/ Size	S Lead Spacing	L Length	H Height	T Thickness	LD Lead Diameter	LL Lead Length Minimum	
C05X	052/056		0.19±0.01	0.19±0.01	0.09±0.01			
OUUN	032/ 030	0.20±0.015	(4.83±0.25)	(4.83±0.25)	(2.29±0.25)			
C06X	0607066	X 062/066 (5.0	(5.08±0.38)	0.29±0.01	0.29±0.01	.29±0.01 0.09±0.01		
COOX	002/ 000		(7.37±0.25)	(7.37±0.25)	(2.29±0.25)	0.025+0.004/-0.002	1 25 (21 75)	
	512		0.48±0.02	0.48±0.02	0.14±0.01	(0.635+0.102/-0.051)	1.25 (31.75)	
OFVV	312	0.40±0.02	(12.19±0.51)	(12.19±0.51)	(3.56±0.25)		1	
C5XX	F00	(10.16+0.5	(10.16±0.51)	0.48±0.02	0.48±0.02	0.24±0.01		
	522	,	(12.19±0.51)	(12.19±0.51)	(6.10±0.25)			

Applications

Typical applications include decoupling, bypass, filtering and transient voltage suppression.

Application Notes

These devices are not recommended for use in overmold applications and/or processes

Qualification/Certification

Commercial Grade products are subject to internal qualification. Details regarding test methods and conditions are referenced in Table 2, Performance & Reliability.

Environmental Compliance

Devices with standard lead finish option of 60% tin (Sn)/40% lead (Pb) do not meet RoHS criteria. Devices with 100% matte tin (Sn) lead finish option are RoHS Compliant (C052 & C062 only).



Electrical Parameters/Characteristics

Item	Parameters/Characteristics
Operating Temperature Range	-55°C to +125°C
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	±15%
Aging Rate (Maximum % Cap Loss/Decade Hour)	3.0%
Dielectric Withstanding Voltage	250% of rated voltage (5±1 second and charge/discharge not exceeding 50 mA)
Dissipation Factor (DF) Maximum Limit at 25°C	3.5%(25 V) and 2.5%(50 V to 250 V)
Insulation Resistance (IR) Limit at 25°C	1,000 megohm microfarads or 100 GΩ (Rated voltage applied for 120±5 seconds at 25°C)

Regarding aging rate: Capacitance measurements (including tolerance) are indexed to a referee time of 1,000 hours. To obtain IR limit, divide $M\Omega$ - μ F value by the capacitance and compare to $G\Omega$ limit. Select the lower of the two limits. Capacitance and dissipation factor (DF) measured under the following conditions:

1 kHz ± 50 Hz and 1.0 ± 0.2 V $_{rms}$ if capacitance ≤ 10 μF

120 Hz ±10 Hz and 0.5 ±0.1 V_{rms} if capacitance > 10 μF

Note: When measuring capacitance it is important to ensure the set voltage level is held constant. The HP4284 and Agilent E4980 have a feature known as Automatic Level Control (ALC). The ALC feature should be switched to "ON."

Post Environmental Limits

High Temperature Life, Biased Humidity, Moisture Resistance						
Dielectric Rated DC Voltage Capacitance Valu		Capacitance Value	DF (%)	Capacitance Shift		
	> 25		3.0			
X7R	16/25	All	5.0	±20%		
	< 16		7.5			



Table 1A - C052 Style/Size (0.20" Lead Spacing), Capacitance Range Waterfall

	C052 Style	/Size (0.20" Lead S	spacing)	
Rated Volt	age (VDC)	50	100	200
Voltag	e Code	5	1	2
Capacitance	Capacitance Tolerance	Capac	citance Code (Available C	apacitance)
10pF		100	100	100
12pF		120	120	120
15pF		150	150	150
18pF		180	180	180
22pF		220	220	220
27pF		270	270	270
33pF		330	330	330
39pF		390	390	390
47pF		470	470	470
56pF		560	560	560
68pF		680	680	680
82pF		820	820	820
100pF		101	101	101
120pF		121 151	121 151	121 151
150pF 180pF		181	181	181
220pF	-	221	221	221
270pF 270pF	-	271	271	271
330pF	-	331	331	331
390pF		391	391	391
470pF		471	471	471
560pF		561	561	561
680pF	-	681	681	681
820pF		821	821	821
1000pF	K = ±10%	102	102	102
1200pF	M = ±20%	122	122	102
1500pF		152	152	
1800pF		182	182	
2200pF		222	222	
2700pF		272	272	
3300pF		332	332	
3900pF		392	392	
4700pF		472	472	
5600pF		562	562	
6800pF		682	682	
8200pF		822	822	
0.01µF		103	103	
0.012µF		123		
0.015µF		153		
0.018µF		183		
0.022µF		223		
0.027μF		273		
0.033µF		333		
0.039µF		393		
0.047µF		473		
0.056µF		563		
0.068µF		683		
0.082µF		823		
0.1μF		104		
Rated Volt		50	100	200
Voltan	e Code	5	1	2



Table 1B - C062 Style/Size (0.20" Lead Spacing), Capacitance Range Waterfall

	C062 Style	/Size (0.20" Lead Sp	pacing)	
Rated Voltage (VDC) Voltage Code		50	100	200
		5	1	2
Capacitance	Capacitance Tolerance	Capaci	tance Code (Available C	apacitance)
1200pF		122	122	122
1500pF		152	152	152
1800pF		182	182	182
2200pF		222	222	222
2700pF		272	272	272
3300pF		332	332	332
3900pF		392	392	392
4700pF		472	472	472
5600pF		562	562	562
6800pF		682	682	682
8200pF		822	822	822
0.01µF		103	103	103
0.012µF		123	123	
0.015µF		153	153	
0.018µF		183	183	
0.022μF		223	223	
0.027µF		273	273	
0.033µF	K = ±10%	333	333	
0.039µF	M = ±20%	393	393	
0.047µF		473	473	
0.056µF		563	563	
0.068µF		683	683	
0.082µF		823	823	
0.1µF		104	104	
0.12µF		124 154		
0.15µF		154		
0.18µF		224		
0.22μF 0.27μF		274		
0.27μF 0.33μF		334		
0.33μF 0.39μF		394		
0.39μF 0.47μF		474		
0.56µF		564		
0.68µF		684		
0.82µF		824		
υ.οzμ r 1.0μF		105		
Rated Volt	ane (VDC)	50	100	200
	e Code	5	1	2



Table 1C - C512 Style/Size (0.40" Lead Spacing), Capacitance Range Waterfall

C512 Style/Size (0.40" Lead Spacing)						
Rated Vo	Rated Voltage (VDC) Voltage Code		100	200		
Volta			1	2		
Capacitance	Capacitance Tolerance	Capacitance Code (Available Capacitance)				
1.0µF 1.5µF 2.0µF 2.2µF	K = ±10% M = ±20%	105 155 205 225				
Rated Vo	Rated Voltage (VDC)		100	200		
Volta	ge Code	5	1	2		

Table 1D - C522 Style/Size (0.40" Lead Spacing), Capacitance Range Waterfall

C522 Style/Size (0.40" Lead Spacing)						
Rated Volt	Rated Voltage (VDC)		100	200		
Voltag	Voltage Code		5 1 2			
Capacitance	Capacitance Tolerance	Capacitance Code (Available Capacitance)				
1.0µF 2.7µF 3.3µF	K = ±10% M = ±20%	105 275 335	105			
Rated Volt	Rated Voltage (VDC)		100	200		
Voltag	Voltage Code		1	2		



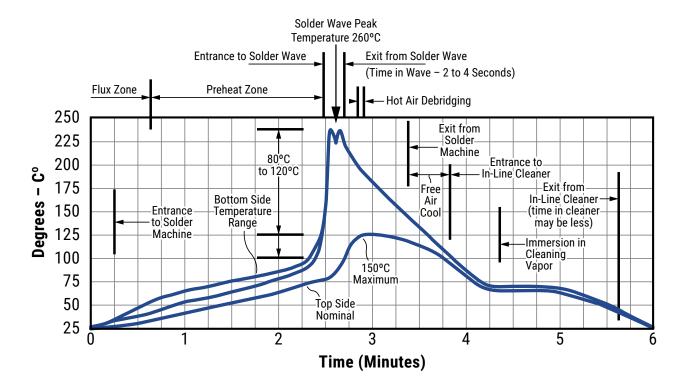
Soldering Process

Recommended Soldering Technique:

- · Solder Wave
- Hand Soldering (Manual)

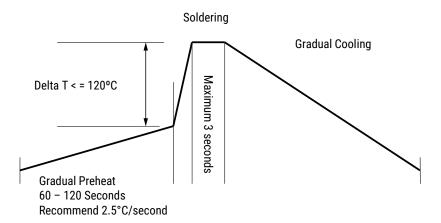
Recommended Soldering Profile:

· Optimum Wave Solder Profile



· Hand Soldering (Manual)

Manual Solder Profile with Pre-heating



KEMET recommends following the guidelines and techniques outlined in technical bulletins F2103 and F9207.



Table 2 - Performance & Reliability: Test Methods and Conditions

Stress	Reference	Test or Inspection Method
		Magnification 50 X. Conditions:
Caldanahilitu	J-STD-002	a) Method B, 4 hours at 155°C, dry heat at 235°C
Solderability	J-51D-002	b) Method B at 215°C category 3
		c) Method D, category 3 at 260°C
Temperature Cycling	JESD22 Method JA-104	1,000 cycles (-55°C to +125°C), Measurement at 24 hours. +/-2 hours after test conclusion.
B: 111 :15	MIL-STD-202	Load Humidity: 1,000 hours 85°C/85% RH and Rated Voltage. Add 100 K ohm resistor. Measurement at 24 hours. +/-2 hours after test conclusion.
Biased Humidity	Method 103	Low Volt Humidity: 1,000 hours 85°C/85% RH and 1.5 V. Add 100 K ohm resistor. Measurement at 24 hours. +/-2 hours after test conclusion.
Moisture Resistance	MIL-STD-202 Method 106	t = 24 hours/cycle. Steps 7a and 7b not required. Unpowered. Measurement at 24 hours. +/-2 hours after test conclusion.
Thermal Shock	MIL-STD-202 Method 107	-55°C/+125°C. Note: Number of cycles required – 300. Maximum transfer time – 20 seconds. Dwell time – 15 minutes. Air – Air.
High Temperature Life	MIL-STD-202 Method 108/EIA-198	1,000 hours at 125°C (85°C for X5R, Z5U and Y5V) with 2 X rated voltage applied.
Storage Life	MIL-STD-202 Method 108	150°C, 0 VDC, for 1,000 hours.
Vibration	MIL-STD-202 Method 204	5 g for 20 minutes, 12 cycles each of 3 orientations. Note: Use 8"X5" PCB .031" thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10 – 2,000 Hz.
Resistance to Soldering Heat	MIL-STD-202 Method 210	Condition B. No pre-heat of samples. Note: single wave solder – procedure 2.
Terminal Strength	MIL-STD-202 Method 211	Conditions A (2.3 kg or 5 lbs)
Mechanical Shock	MIL-STD-202 Method 213	Figure 1 of Method 213, Condition F.
Resistance to Solvents	MIL-STD-202 Method 215	Add aqueous wash chemical, OKEM Clean or equivalent.

Storage & Handling

Ceramic chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature—reels may soften or warp, and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C, and maximum storage humidity not exceed 70% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts, and atmospheres should be free of chlorine and sulfur bearing compounds. For optimized solderability, chip stock should be used promptly, preferably within 1.5 years of receipt.



Packaging Details

Lead Spacing	Component Pitch (P1)
0.100 (2.54)	5.08
0.200 (5.08)	3.81
0.400 (10.16)	7.62
0.170 (4.32)	
0.220 (5.59)	
0.275 (6.98)	
0.300 (7.62)	
0.375 (9.52)	
0.475 (12.06)	
0.575 (14.60)	
0.675 (17.14)	

Packaging Quantities

Style/ Size	Standard Bulk Quantity	Ammo Pack Quantity Maximum	Reel Quantity Maximum (12" Reel)	
052	100/Bag	2000	2000	
062	100/Bag	1500	1500	
512	Can Natal	NI/A	NI/A	
522	See Note ¹	N/A	N/A	

¹ Quantity varies. For further details, please contact KEMET.

Marking

C052C & C062C STANDARD MARKING

	FHON	DACK	
Style——— Temperature Characteristic———	C062 X7B	100V K	Voltage KEMET
Capacitance, Capacitance Tolerance-	104K	0811	— Date Code

C512 & C522 STANDARD MARKING

KEMET C512X7B	KEMET SIZE and Temperature Characteristic
105K 50V	Capacitance, Capacitance Tolerance, Voltage
0832	



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